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J. Mike Amerson
Williams, Morgan & Amerson, P.C.
Suite 1100
10333 Richmond
Houston, TX 77042

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FILING RECEIPT



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DOCKETING DEPT.

Applicant(s)

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Michael Friedemann, Dresden, GERMANY;
Volker Kahlert, Dresden, GERMANY;

WILLIAMS, MORGAN & AMERSON

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Title

Method of forming a conductive barrier layer having improved adhesion and resistivity characteristics